

# INTERNATIONAL STANDARD

# IEC 61189-3

1997

AMENDMENT 1  
1999-07

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## Amendment 1

### **Test methods for electrical materials, interconnection structures and assemblies –**

### **Part 3: Test methods for interconnection structures (printed boards)**

#### *Amendement 1*

#### *Méthodes d'essai pour les matériaux électriques, les structures d'interconnexion et les ensembles –*

#### *Partie 3: Méthodes d'essai des structures d'interconnexion (cartes imprimées)*

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International Electrotechnical Commission  
Telefax: +41 22 919 0300

3, rue de Varembeé Geneva, Switzerland  
e-mail: [inmail@iec.ch](mailto:inmail@iec.ch) IEC web site <http://www.iec.ch>



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